

Welcome to [E-XFL.COM](#)

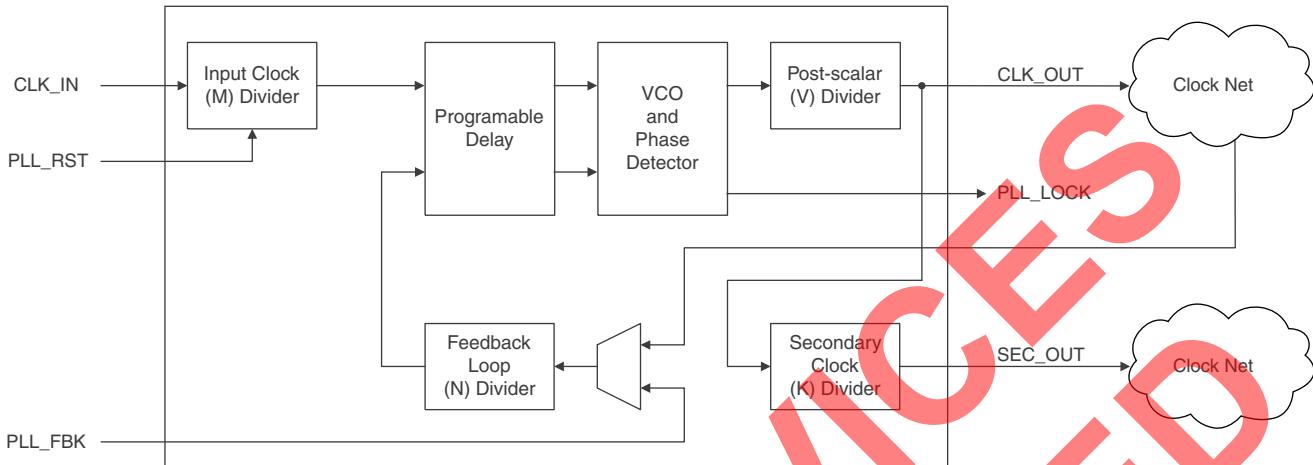
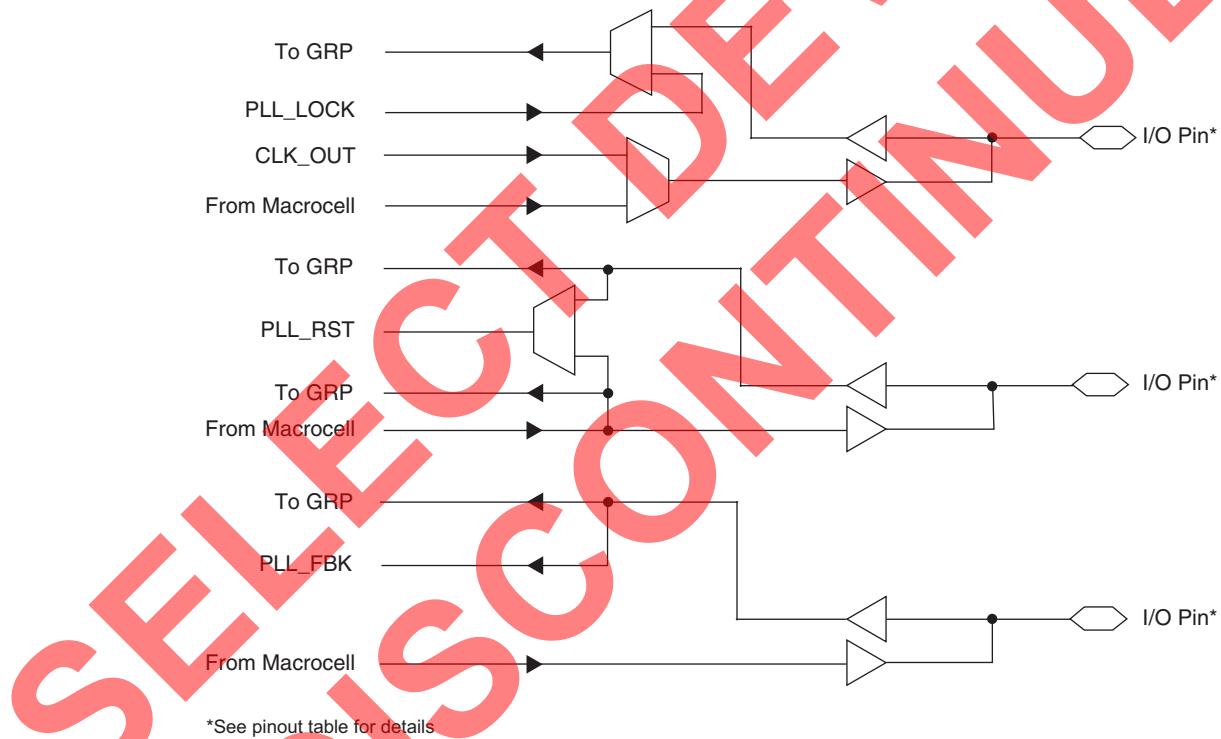
## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	2.3V ~ 2.7V
Number of Logic Elements/Blocks	8
Number of Macrocells	256
Number of Gates	-
Number of I/O	141
Operating Temperature	-40°C ~ 105°C (TJ)
Mounting Type	Surface Mount
Package / Case	256-BGA
Supplier Device Package	256-FPBGA (17x17)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5256mb-75fn256i">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc5256mb-75fn256i</a>

**Figure 15. PLL Block Diagram****Figure 16. Connection of Optional PLL Inputs and Outputs**

\*See pinout table for details

In order to facilitate the multiply and divide capabilities of the PLL, each PLL has dividers associated with it: M, N and K. The M divider is used to divide the clock signal, while the N divider is used to multiply the clock signal. The K divider is only used when a secondary clock output is needed. This divider divides the primary clock output and feeds to a separate global clock net. The V divider is used to provide lower frequency output clocks, while maintaining a stable, high frequency output from the PLL's VCO circuit. The PLL also has a delay feature that allows the output clock to be advanced or delayed to improve set-up and clock-to-out times for better performance. For more information on the PLL, please refer to TN1003, [sysCLOCK PLL Usage Guide for ispXPGA, ispGDX2, ispXPLD and ispMACH 5000VG Devices](#).

## Output Sharing Array (OSA)

A number of I/O pads are available in each sysIO bank to route the selected number of macrocells from the MFB outputs directly to the I/O pads in logic mode. In the ispXPLD 5000MX, the large number of inputs and PTs to the MFB as well as the presence of the PTSA can cover most routing flexibility of signals to I/O cells. The Output Sharing Array gives additional routing capability and I/O access to an MFB when a wide output function takes up the whole MFB and cannot be easily divided across multiple MFBs. By using the OSA, the wide output function, such as 32-bit FIFO, can have all of its output signals from the one MFB routed to I/O cells. In a given I/O block, the wide output functions must share the I/O pads with other logic functions.

The OSA bypass option routes the MFB signal directly to the I/O cell, allowing a direct connection to the I/O cell. The logic functions use the option to provide faster speed to the outputs. The Logic Signal Connection tables list the OSA bypass as the primary macrocell and OSA options as alternate macrocells. Similarly, the Alternate Input listing in the table shows the alternate macrocell input connection for a given I/O pin. Figure 17 shows the alternate macrocell connections in an I/O cell.

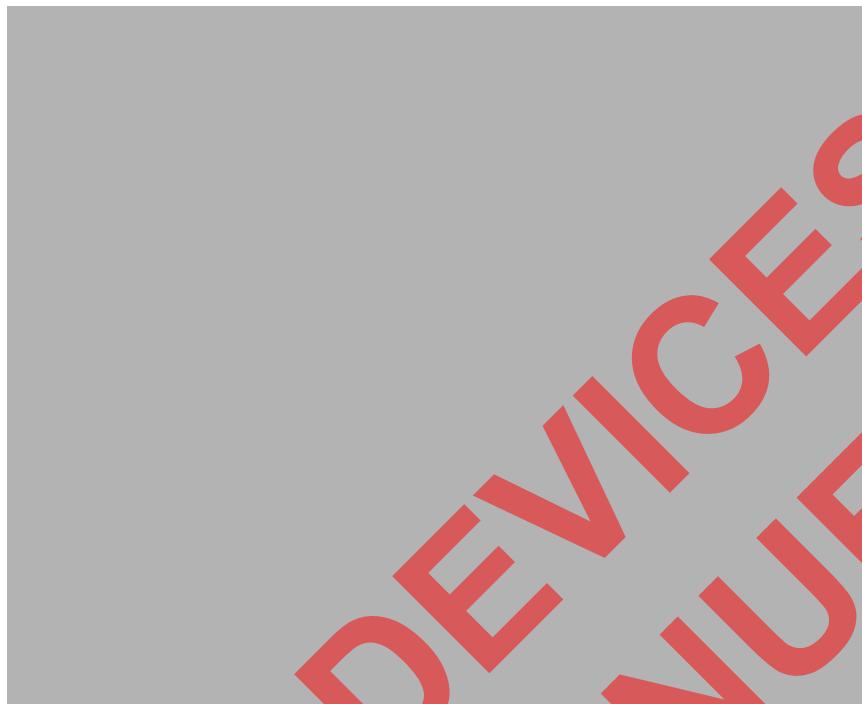
## sysIO Banks

The ispXPLD 5000MX devices are divided into four sysIO banks, consisting of multiple I/O cells, where each bank is capable of supporting 16 different I/O standards. Each sysIO bank has its own I/O voltage ( $V_{CCO}$ ) and reference voltage ( $V_{REF}$ ) resources allowing complete independence from the others.

### I/O Cell

The I/O cell of the ispXPLD 5000MX devices contains an output enable (OE) MUX, a programmable tri-state output buffer, a programmable input buffer, and programmable bus-maintenance circuitry.

The I/O cell receives inputs from its associated macrocells and the device pin. The I/O cell has a feedback line to its associated macrocells and a direct path to GRP. The output enable (OE) MUX selects the OE signal per I/O cell. The inputs to the OE MUX are the four global PTOE signals, PTOE and the two GOE signals. The OE MUX also has the ability to choose either the true or inverse of each of these signals. The output of the OE MUX goes through a logical AND with the TOE signal to allow easy tri-stating of the outputs for testing purposes. The MFBs are grouped into segments of four for the purpose of generating Shared PTOE signals. Each Shared PTOE signal is derived from PT 163 from one of the four MFBs. Table 10 shows the segments. The PTOE signal is derived from the first product term in each macrocell cluster, which is directly routed to the OE MUX. Therefore, every I/O cell can have a different OE signal. Figure 17 is a graphical representation of the I/O cell.

**Figure 17. I/O Cell****Table 10. Shared PTOE Segments**

Device	MFBs Associated With Segments
ispXPLD 5256MX	(A, B, C, D) (E, F, G, H)
ispXPLD 5512MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P)
ispXPLD 5768MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P) (Q, R, S, T) (U, V, W, Z)
ispXPLD 51024MX	(A, B, C, D) (E, F, G, H) (I, J, K, L) (M, N, O, P) (Q, R, S, T) (U, V, W, Z) (Y, Z, AA, AB) (AC, AD, AE, AF)

### sysIO Standards

Each I/O within a bank is individually configurable based on the  $V_{CCO}$  and  $V_{REF}$  settings. Some standards also require the use of an external termination voltage. Table 12 lists the sysIO standards with the typical values for  $V_{CCO}$ ,  $V_{REF}$  and  $V_{TT}$ . For more information on the sysIO capability, refer to TN1000, [sysIO Usage Guidelines for Lattice Devices](#).

**Table 11. Number of I/Os per Bank**

Device	Maximum Number of I/Os per Bank (n)
ispXPLD 5256MX	36
ispXPLD 5512MX	68
ispXPLD 5768MX	96
ispXPLD 51024MX	96

## Supply Current

Symbol	Parameter	Condition	Min.	Typ. <sup>3</sup>	Max.	Units
<b>ispXPLD 5256</b>						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	26	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	16	—	mA
$I_{CCO}$	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{unloaded}$	—	3	—	mA
$I_{CCP}$	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
$I_{CCJ}$	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
<b>ispXPLD 5512</b>						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	33	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	22	—	mA
$I_{CCO}$	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{unloaded}$	—	3	—	mA
$I_{CCP}$	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
$I_{CCJ}$	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA
<b>ispXPLD 5768</b>						
$I_{CC}^{1,2}$	Operating Power Supply Current	$V_{CC} = 3.3V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 2.5V, f = 1.0MHz$	—	40	—	mA
		$V_{CC} = 1.8V, f = 1.0MHz$	—	30	—	mA
$I_{CCO}$	Standby Power Supply Current (per I/O Bank)	$V_{CCO} = 3.3V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 2.5V, f = 1.0MHz, \text{unloaded}$	—	4	—	mA
		$V_{CCO} = 1.8V, f = 1.0MHz, \text{unloaded}$	—	3	—	mA
$I_{CCP}$	PLL Power Supply Current (per PLL Bank)	$V_{CCP} = 3.3V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 2.5V, f = 10MHz$	—	11	—	mA
		$V_{CCP} = 1.8V, f = 10MHz$	—	3	—	mA
$I_{CCJ}$	Standby IEEE 1149.1 TAP Power Supply Current	$V_{CCJ} = 3.3V$	—	1	—	mA
		$V_{CCJ} = 2.5V$	—	1	—	mA
		$V_{CCJ} = 1.8V$	—	1	—	mA

**ispXPLD 5000MX Family External Switching Characteristics (Continued)<sup>1, 2, 3</sup>**

Over Recommended Operating Conditions

Parameter	Description	-4		-45		-5		-52		-75		Units
		Min.	Max.									
$f_{MAX}$ (RAM) <sup>5</sup>	Clock Frequency to RAM in:											
	Single Port Mode	—	155	—	155	—	155	—	155	—	93	MHz
	Dual Port Mode	—	155	—	155	—	155	—	155	—	93	MHz
$f_{MAX}$ (FIFO) <sup>5</sup>	Pseudo Dual Port Mode	—	180	—	180	—	160	—	160	—	106	MHz
	Clock Frequency to FIFO	—	225	—	220	—	210	—	210	—	132	MHz
$t_{PWR\_ON}$	Power-on Time	—	200	—	200	—	200	—	200	—	200	μs

Timing v.1.8

1. Timing numbers are based on default LVCMS 1.8 I/O buffers. Use timing adjusters provided to calculate timing for other standards.
2. Measured using standard switching circuit, global routing loading of 1, worst case PTSA loading and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using GRP feedback.
5. CAM, FIFO, RAM  $f_{MAX}$  specification used shared PT Clk.

**SELECT DEVICE DISCONTINUED**

## ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.									
$t_{PDPRWH}$	R/W Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{PDPDATAS}$	Data Setup before Clock Time	—	-0.27	—	-0.27	—	-0.22	—	-0.22	—	-0.21	—	ns
$t_{PDPDATAH}$	Data Hold time after Clock Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{PDPRCLKO}$	Read Clock to Output Delay	—	—	5.08	—	5.02	—	5.66	—	5.45	—	8.54	ns
$t_{PDPCLKSKEW}$	Opposite Clock Cycle Delay	—	1.40	—	1.40	—	1.76	—	1.76	—	1.83	—	ns
$t_{PDPRSTO}$	Reset to RAM Output Delay	—	—	3.30	—	3.30	—	4.13	—	4.13	—	4.29	ns
$t_{PDPRSTR}$	Reset Recovery Time	—	1.20	—	1.20	—	1.50	—	1.50	—	1.56	—	ns
$t_{PDPRSTPW}$	Reset Pulse Width	—	0.14	—	0.14	—	0.18	—	0.18	—	0.19	—	ns
<b>Dual Port RAM</b>													
$t_{DPMSAS}$	Memory Select A Setup Before R/W A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPMSAH}$	Memory Select Hold time after R/W A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPCEAS}$	Clock Enable A Setup before Clock A Time	—	3.72	—	3.72	—	3.72	—	3.72	—	4.84	—	ns
$t_{DPCEAH}$	Clock Enable A Hold time after Clock A Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
$t_{DPADDAS}$	Address A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPADDAH}$	Address A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPRWAS}$	R/W A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPRWAH}$	R/W A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPDATAAS}$	Write Data A Setup before Clock A Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPDATAAH}$	Write Data A Hold time after Clock A Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPMSBS}$	Memory Select B Setup Before R/W B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPMSBH}$	Memory Select Hold time after R/W B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns

## ispXPLD 5000MX Family Internal Switching Characteristics (Continued)

Over Recommended Operating Conditions

Parameter	Description	Base Parameter	-4		-45		-5		-52		-75		Units
			Min.	Max.									
$t_{DPCEBS}$	Clock Enable B Setup before Clock B Time	—	2.33	—	2.33	—	2.33	—	2.33	—	3.03	—	ns
$t_{DPCEBH}$	Clock Enable Hold B after Clock B Time	—	-2.95	—	-2.95	—	-2.95	—	-2.95	—	-2.27	—	ns
$t_{DPADDBS}$	Address B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPADDBH}$	Address B Hold time after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPRWBS}$	R/W B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPRWBH}$	R/W B Hold time after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPDATABS}$	Write Data B Setup before Clock B Time	—	-0.27	—	-0.27	—	-0.27	—	-0.27	—	-0.21	—	ns
$t_{DPDATABH}$	Write Data B Hold after Clock B Time	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	-0.01	—	ns
$t_{DPRCLKAO}$	Read Clock A to Output Delay	—	—	5.97	—	5.92	—	5.86	—	5.65	—	9.86	ns
$t_{DPRCLKBO}$	Read Clock B to Output Delay	—	—	5.16	—	5.16	—	5.16	—	5.16	—	6.71	ns
$t_{DPCLKSKEW}$	Opposite Clock Cycle Delay	—	1.40	—	1.40	—	1.40	—	1.40	—	1.83	—	ns
$t_{DPRSTO}$	Reset to RAM Output Delay	—	—	3.30	—	3.30	—	3.30	—	3.30	—	4.29	ns
$t_{DPRSTR}$	Reset Recovery Time	—	1.20	—	1.20	—	1.20	—	1.20	—	1.56	—	ns
$t_{DPRSTPW}$	Reset Pulse Width	—	0.14	—	0.14	—	0.14	—	0.14	—	0.19	—	ns

Timing v.1.8

1. The PT-delay to clock of RAM/FIFO/CAM should be  $t_{BCLK}$  instead of  $t_{PTCLK}$ .
2. The PT-delay to set/reset of RAM/FIFO/CAM should be  $t_{BSR}$  instead of  $t_{PTSR}$ .

## ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.									
LVCMOS_18_8mA_out	Using 1.8V CMOS Standard, 8mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_18_12mA_out	Using 1.8V CMOS Standard, 12mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.0	—	0.0	—	0.0	—	0.0	—	0.0	ns
LVCMOS_25_4mA_out	Using 2.5V CMOS Standard, 4mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVCMOS_25_5.33mA_out	Using 2.5V CMOS Standard, 5.33 mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	1.0	—	1.0	—	1.0	—	1.0	—	1.0	ns
LVCMOS_25_8mA_out	Using 2.5V CMOS Standard, 8mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVCMOS_25_12mA_out	Using 2.5V CMOS Standard, 12mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVCMOS_25_16mA_out	Using 2.5V CMOS Standard, 16mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns
LVCMOS_33_4mA_out	Using 3.3V CMOS Standard, 4mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVCMOS_33_5.33mA_out	Using 3.3V CMOS Standard, 5.33mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	1.2	—	1.2	—	1.2	—	1.2	—	1.2	ns
LVCMOS_33_8mA_out	Using 3.3V CMOS Standard, 8mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVCMOS_33_12mA_out	Using 3.3V CMOS Standard, 12mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVCMOS_33_16mA_out	Using 3.3V CMOS Standard, 16mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVCMOS_33_20mA_out	Using 3.3V CMOS Standard, 20mA Drive	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
AGP_1X_out	Using AGP 1x Standard	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
CTT25_out	Using CTT 2.5V	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
CTT33_out	Using CTT 3.3V	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
GTL+_out	Using GTL+	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns

## ispXPLD 5000MX Family Timing Adders (Continued)

Parameter	Description	Base Param.	-4		-45		-5		-52		-75		Units
			Min.	Max.									
HSTL_I_out	Using HSTL 2.5V, Class I	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
HSTL_III_out	Using HSTL 2.5V, Class III	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
HSTL_IV_out	Using HSTL 2.5V, Class IV	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
LVDS_out	Using Low Voltage Differential Signaling (LVDS)	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.8	—	0.8	—	0.8	—	0.8	—	0.8	ns
LVPECL_out	Using Low Voltage PECL	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
PCI_out	Using PCI Standard	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.6	—	0.6	—	0.6	—	0.6	—	0.6	ns
SSTL2_I_out	Using SSTL 2.5V, Class I	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.3	—	0.3	—	0.3	—	0.3	—	0.3	ns
SSTL2_II_out	Using SSTL 2.5V, Class II	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.5	—	0.5	—	0.5	—	0.5	—	0.5	ns
SSTL3_I_out	Using SSTL 3.3V, Class I	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.2	—	0.2	—	0.2	—	0.2	—	0.2	ns
SSTL3_II_out	Using SSTL 3.3V, Class II	$t_{IOBUF}$ , $t_{IOEN}$ , $t_{IODIS}$	—	0.4	—	0.4	—	0.4	—	0.4	—	0.4	ns

Timing v.1.8

Signals	208 PQFP <sup>4</sup>	256 fpBGA <sup>3,5</sup>	484 fpBGA, 5 <sup>3</sup>	672 fpBGA <sup>3,5</sup>
VCC	10, 49, 76, 114, 153, 180	D4, D13, F6, F11, L6, L11, N4, N13	A17, A6, AA2, AA21, AB17, AB6, B2, B21, D19, D4, F1, F22, G10, G11, G12, G13, K16, K7, L16, L7, M16, M7, T10, T11, T12, T13, T14, T9, U1, U22, W19, W4	AA21, AA6, F21, F6, G20, G7, J13, J14, K13, K14, L13, L14, M13, M14, N10, N11, N12, N15, N16, N17, N18, N9, P10, P11, P12, P15, P16, P17, P18, P9, R13, R14, T13, T14, U13, U14, V13, V14, Y20, Y7
VCCO0	5, 17, 189, 204	A1, F7, G6	B9, C3, G8, G9, H7, J2, J7, P4	H10, H11, H8, H9, J8, J9, K8, L8, M8, N8
VCCO1	42, 57, 72	K6, L7, T1	AA9, R7, T3, T8, Y3	P8, R8, T8, U8, V8, V9, W10, W11, W8, W9
VCCO2	85, 100, 107, 121	K11, L10, T16	AA14, R16, T15, T20, Y20	P19, R19, T19, U19, V18, V19, W12, W13, W14, W15, W16, W17, W18, W19
VCCO3	146, 161, 176	A16, F10, G11	B14, C20, G14, G15, H16, J16, J21, P19	H12, H13, H14, H15, H16, H17, H18, H19, J18, J19, K19, L19, M19, N19
VCCP	136	J16	M22	N25
VCCJ	27	J1	M1	N4
GND	15, 29, 44, 81, 119, 148, 185, 7, 19, 191, 205, 40, 56, 70, 87, 101, 109, 123, 144, 160, 174	K1, C3, C14, E5, E12, G7, G8, G9, G10, H7, H8, H9, H10, J7, J8, J9, J10, K7, K8, K9, K10, M5, M12, P3	N1, A1, A2, A21, A22, AA1, AA22, AB1, AB22, B1, B22, C15, C8, D11, D12, E18, E5, F17, F6, G16, G7, H10, H11, H12, H13, H14, H15, H20, H3, H8, H9, J10, J11, J12, J13, J14, J15, J8, J9, K10, K11, K12, K13, K14, K15, K8, K9, L10, L11, L12, L13, L14, L15, L19, L4, L8, L9, M10, M11, M12, M13, M14, M19, M4, M9, N10, N11, N12, N13, N14, N9, P10, P11, P12, P13, P14, P9, R10, R11, R12, R13, R14, R15, R8, R9, T16, T7, W11, W12, Y15, Y8	A11, A16, A2, A25, AE1, AE2, AE25, AE26, AF11, AF16, AF2, AF25, B1, B2, B25, B26, J10, J11, J12, J15, J16, J17, K10, K11, K12, K15, K16, K17, K18, K9, L1, L10, L11, L12, L15, L16, L17, L18, L26, L9, M10, M11, M12, M15, M16, M17, M18, M9, N13, N14, P13, P14, R10, R11, R12, R15, R16, R17, R18, R9, T1, T10, T11, T12, T15, T16, T17, T18, T26, T9, U10, U11, U12, U15, U16, U17, U18, U9, V10, V11, V12, V15, V16, V17
GNDP	134	K16	N22	P26
NC <sup>2</sup>	—	<b>5256MX:</b> A2, A11, A12, A15, B2, B12, B15, B16, C4, C12, C15, C16, D1, D11, D14, D15, D16, E1, E4, E10, E11, E13, E14, F4, F5, F12, F13, L1, L4, M3, M7, M13, N2, N6, P1, P2, P5, P6, P13, P14, P15, P16, R1, R2, R4, R5, R6, R16, T2, T3, T4, T5, T6 <b>5512MX/5768MX:</b> L1	<b>5512MX:</b> P1, AA19, AB2, AB21, J17, J6, K1, K17, K18, K19, K2, K20, K21, K22, K3, K4, K5, K6, L1, L17, L18, L2, L20, L21, L22, L3, L5, L6, M15, M17, M18, M2, M20, M21, M3, M5, M6, M8, N15, N17, N18, N19, N2, N20, N21, N3, N4, N5, N6, N8, P15, P17, P18, P2, P21, P22, P5, P6, P8, U17, U6, V18, V5, W6 <b>5768MX/51024MX:</b> None	A12, A13, A14, A15, AA10, AA11, AA12, AA13, AA14, AA15, AA16, AA17, AA7, AB10, AB11, AB12, AB13, AB14, AB15, AB16, AB17, AC10, AC11, AC12, AC13, AC14, AC15, AC16, AC17, AD11, AD12, AD13, AD14, AD15, AD16, AE11, AE12, AE13, AE14, AE15, AE16, AF12, AF13, AF14, AF15, B11, B12, B13, B14, B15, B16, C11, C12, C13, C14, C15, C16, C3, D10, D11, D12, D13, D14, D15, D16, D17, E10, E11, E12, E13, E14, E15, E16, E17, E6, E7, E8, F10, F11, F12, F13, F14, F15, F16, F17, G10, G11, G12, G13, G14, G15, G16, G17, Y10, Y11, Y12, Y13, Y14, Y15, Y16, Y17

1. All grounds must be electrically connected at the board level.

2. NC pins should not be connected to any active signals, V<sub>CC</sub> or GND.

3. Balls for GND, V<sub>CC</sub> and V<sub>CCOx</sub> are connected within the substrate to their respective common signals. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

4. Pin orientation follows the conventional counter-clockwise order from pin 1 marking of the topside view.

5. Internal GNDs and I/O GNDs (Bank 0 - Bank 3) are connected inside package. V<sub>CCO</sub> balls connect to four power planes within the package, one each for V<sub>CCOx</sub>.

## ispXPLD 5256MX Logic Signal Connections

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
0	61N	H30	G17	H17	H31	B1
0	61P	H28	G16	H16	H29	C1
0	62N	H26	G15	H15	H27	D3
0	62P	H24	G14	H14	H25	C2
0	63N	H22	G13	H13	H23	E3
0	63P	H21	G12	H12	-	D2
-	-	VCC	-	-	-	VCC
0	64N	H20	G11	H11	-	E2
0	64P	H18/CLK_OUT0	G10	H10	H19	F2
0	65N	H16	G9	H9	H17	F1
0	65P	H14	G8	H8	H15	G1
-	-	GND	-	-	-	GND
0	66N	H12	G7	H7	H13	F3
-	-	VCCO0	-	-	-	VCCO0
0	66P	H10	G6	H6	H11	G5
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	67N	H8	G5	H5	H9	H5
0	67P	H6/PLL_RST0	G4	H4	H7	G4
0	68N	H5	-	-	-	G3
0	68P	H4/PLL_FBK0	-	-	-	H3
0	69N	H2	-	-	H3	G2
0	69P	H0	-	-	H1	H1
-	GCLK0P	GCLK0	-	-	-	H2
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table
-	GCLK0N	GCLK1	-	-	-	J2
-	-	GND	-	-	-	GND
-	-	TDI	-	-	-	H6
-	-	TMS	-	-	-	H4
-	-	TCK	-	-	-	J6
-	-	TDO	-	-	-	K2
1	0P	A0/DATA0	A0	B0	A1	K3
1	0N	A2/DATA1	A1	B1	A3	J3
1	1P	A4/DATA2	A2	B2	-	J5
1	1N	A5/DATA3	A3	B3	-	J4
1	2P	A6/DATA4	A4	B4	A7	L2
1	2N	A8/DATA5	A5	B5	A9	M1
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	3P	A10/DATA6	A6	B6	A11	K4
-	-	VCCO1	-	-	-	VCCO1
1	3N	A12/DATA7	A7	B7	A13	L3
-	-	GND	-	-	-	GND
1	4P	A14/INITB	A8	B8	A15	K5

## ispXPLD 5256MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
1	4N	A16/CSB	A9	B9	A17	L5
1	5P	A18/READ	A10	B10	A19	N1
1	5N	A20/CCLK	A11	B11	A21	M2
-	-	VCC	-	-	-	VCC
-	-	DONE	-	-	-	M4
1	6P	A22	A12	B12	A23	N3
1	6N	A24	A13	B13	A25	P4
1	7P	A26	A14	B14	A27	N5
1	7N	A28	A15	B15	A29	M6
-	-	PROGRAMB	-	-	-	R3
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
-	-	VCCO1	-	-	-	VCCO1
-	-	CFG0	-	-	-	L8
1	8P	B2	A16	B16	B3	T7
1	8N	B4	A17	B17	-	R7
1	9P	B5	A18	B18	-	N7
1	9N	B6	A19	B19	B7	P7
1	10P	B8	A20	B20	B9	T8
1	10N	B10	A21	B21	B11	R8
1	11P	B12	A22	B22	B13	M8
1	11N	B14	A23	B23	B15	P8
1	-	B16/VREF1	-	-	B17	L9
1	12P	B18	A24	B24	B19	N8
1	12N	B20	A25	B25	-	M9
-	-	GND (Bank 1)	-	-	-	GND (Bank 1)
1	13P	B21	A26	B26	-	N10
-	-	VCCO1	-	-	-	VCCO1
1	13N	B22	A27	B27	B23	T9
1	14P	B24	A28	B28	B25	T10
1	14N	B26	A29	B29	B27	R9
-	-	VCC	-	-	-	VCC
1	15P	B28	A30	B30	B29	P9
1	15N	B30	A31	B31	B31	N9
2	16P	C0	C0	D0	C1	T11
2	16N	C2	C1	D1	C3	T12
2	17P	C4	C2	D2	-	P10
2	17N	C5	C3	D3	-	R10
2	18P	C6	C4	D4	C7	R11
-	-	VCCO2	-	-	-	VCCO2
2	18N	C8	C5	D5	C9	M10
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)
2	19P	C10	C6	D6	C11	M11
2	19N	C12	C7	D7	C13	T13

**ispXPLD 5256MX Logic Signal Connections (Continued)**

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Input	256 fpBGA Ball Number
			Macrocell 1	Macrocell 2		
3	51N	F2	E1	F1	F3	B8
3	51P	F0	E0	F0	F1	C8
0	52N	G30	G31	H31	G31	B7
0	52P	G28	G30	H30	G29	A7
-	-	GND	-	-	-	NC
0	53N	G26	G29	H29	G27	D7
0	53P	G24	G28	H28	G25	C7
0	54N	G22	G27	H27	G23	B6
-	-	VCCO0	-	-	-	VCCO0
0	54P	G21	G26	H26	-	E7
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)
0	55N	G20	G25	H25	-	E6
0	55P	G18	G24	H24	G19	A6
0	56N	G16/VREF0	G3	H3	G17	A5
0	56P	G14	G2	H2	G15	A4
0	57N	G12	G23	H23	G13	B5
0	57P	G10	G22	H22	G11	A3
0	58N	G8	G21	H21	G9	B4
0	58P	G6	G20	H20	G7	B3
0	59N	G5	G19	H19	-	C5
0	59P	G4	G18	H18	-	C6
0	60N	G2	G1	H1	G3	D5
0	60P	G0	G0	H0	G1	D6
-	-	VCCO0	-	-	-	VCCO0
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)

Global Clock LVDS pair options: GCLK0 and GCLK1, as well as GCLK2 and GCLK3, can be paired together to receive differential clocks; where GCLK0 and GCLK3 are the positive LVDS inputs

**ispXPLD 5768MX Logic Signal Connections (Continued)**

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
0	143N	U22	U27	W27	U23	—	K6
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	143P	U20	U26	W26	U21	—	K3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	144N	U18	U25	W25	U19	—	K5
0	144P	U16	U24	W24	U17	—	K2
0	145N	U14	U23	W23	U15	—	L5
0	145P	U12	U22	W22	U13	—	K1
0	146N	U10	U21	W21	U11	—	L6
0	146P	U8	U20	W20	U9	—	L1
0	147N	U6	U19	W19	U7	—	M5
0	147P	U4	U18	W18	U5	—	L2
0	148N	U2	U17	W17	U3	—	N5
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	148P	U0	U16	W16	U1	—	L3
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	149N	W30	U15	W15	W31	—	M6
0	149P	W28	U14	W14	W29	—	M2
0	150N	W26	U13	W13	W27	—	P5
-	-	VCC	-	-	-	VCC	VCC
0	150P	W24	U12	W12	W25	—	P6
0	151N	W22	U11	W11	W23	—	M3
0	151P	W20	U10	W10	W21	—	N6
0	152N	W18	U9	W9	W19	—	N2
0	152P	W16	U8	W8	W17	—	P1
-	-	GND	-	-	-	GND	GND
0	153N	W14	U7	W7	W15	—	N3
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	153P	W12	U6	W6	W13	—	M8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	154N	W10	U5	W5	W11	—	N8
0	154P	W8	U4	W4	-	—	P2
0	155N	W6	U3	W3	W7	—	P8
0	155P	W4	U2	W2	W5	—	N4
0	156N	W2	U1	W1	W3	G2	H1
0	156P	W0	U0	W0	W1	H1	J1
-	GCLK0P	GCLK0	-	-	-	H2	N7
-	-	VCCJ	-	-	-	See Power Supply and NC Connections Table	
-	GCLK0N	GCLK1	-	-	-	J2	P7
-	-	GND	-	-	-	GND	GND
-	-	TDI	-	-	-	H6	R1
-	-	TMS	-	-	-	H4	R2

## ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
2	46N	G6	H19	-	G7	-	AB19
2	47P	G8	H20	-	G9	-	AA19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	47N	G10	H21	-	G11	-	U17
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	48P	G12	H22	-	G13	-	V18
2	48N	G14	H23	-	G15	-	AB21
2	49P	G16	H24	-	G17	-	U18
2	49N	G18	H25	-	G19	-	T17
2	50P	G20	H26	-	G21	R16	AB20
2	50N	G22	H27	-	G23	P16	AA20
2	51P	G24	H28	-	G25	N15	Y19
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	51N	G26	H29	-	G27	N14	V19
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	52P	G28	F16	H16	G29	N16	T18
2	52N	G30	F17	H17	G31	M16	R17
2	53P	H0	F18	H18	H1	M14	U19
2	53N	H2	F19	H19	H3	M15	T19
2	54P	H4	H30	E24	H5	-	V20
-	-	VCC	-	-	-	VCC	VCC
2	54N	H6	H31	E26	H7	-	U20
2	55P	H8	F20	H20	H9	L13	W20
2	55N	H10	F21	H21	H11	L12	Y21
2	56P	H12	F22	H22	H13	L15	R18
2	56N	H14	F23	H23	H15	L16	R19
-	-	GND	-	-	-	GND	GND
2	57P	H16	F24	H24	H17	L14	W21
-	-	VCCO2	-	-	-	VCCO2	VCCO2
2	57N	H18	F25	H25	H19	K15	Y22
-	-	GND (Bank 2)	-	-	-	GND (Bank 2)	GND (Bank 2)
2	58P	H20	F26	H26	H21	K14	R20
2	58N	H22	F27	H27	H23	K12	P20
2	59P	H24	F28	H28	H25	K13	T21
2	59N	H26	F29	H29	H27	J13	R21
2	60P	H28	F30	H30	H29	J14	U21
2	60N	H30	F31	H31	H31	J12	V21
-	-	TOE	-	-	-	J15	W22
-	-	RESET	-	-	-	J11	V22
-	-	GOE0	-	-	-	H11	T22
-	-	GOE1	-	-	-	H13	R22
-	-	GNDP	-	-	-	See Power Supply and NC Connections Table	

## ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	GCLK3N	GCLK2	-	-	-	H15	P16
-	-	VCCP	-	-	-	See Power Supply and NC Connections Table	
-	GCLK3P	GCLK3	-	-	-	H16	N16
3	61N	J0	L31	J31	-	H14	J22
3	61P	J2	L30	J30	J3	G16	H22
3	62N	J4	L29	J29	J5	—	N19
3	62P	J6	L28	J28	J7	—	P15
3	63N	J8	L27	J27	J9	—	P21
3	63P	J10	L26	J26	J11	—	N15
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	64N	J12	L25	J25	J13	—	M15
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	64P	J14	L24	J24	J15	—	N20
-	-	GND	-	-	-	GND	GND
3	65N	J16	L23	J23	J17	—	P22
3	65P	J18	L22	J22	J19	—	N21
3	66N	J20	L21	J21	J21	—	N17
3	66P	J22	L20	J20	J23	—	M20
3	67N	J24	L19	J19	J25	—	P17
-	-	VCC	-	-	-	VCC	VCC
3	67P	J26	L18	J18	J27	—	P18
3	68N	J28	L17	J17	J29	—	M21
3	68P	J30	L16	J16	J31	—	M17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	69N	L0	L15	J15	-	—	L20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	69P	L2	L14	J14	L3	—	N18
3	70N	L4	L13	J13	L5	—	L21
3	70P	L6	L12	J12	L7	—	M18
3	71N	L8	L11	J11	L9	—	L22
3	71P	L10	L10	J10	L11	—	L17
3	72N	L12	L9	J9	L13	—	K22
3	72P	L14	L8	J8	L15	—	L18
3	73N	L16	L7	J7	L17	—	K21
3	73P	L18	L6	J6	L19	—	K18
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	74N	L20	L5	J5	L21	—	K20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	74P	L22	L4	J4	L23	—	K17
3	75N	L24	L3	J3	L25	—	K19
3	75P	L26	L2	J2	L27	—	J17
3	76N	L28	L1	J1	L29	G15	E22

## ispXPLD 5768MX Logic Signal Connections (Continued)

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
3	76P	L30/PLL_FBK1	L0	J0	L31	F15	E21
3	77N	M0/PLL_RST1	P27	N27	M1	H12	G22
3	77P	M2	P26	N26	M3	G14	F21
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	78N	M4	P25	N25	M5	F16	H21
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	78P	M6	P24	N24	-	E16	G21
-	-	GND	-	-	-	GND	GND
3	79N	M8	P23	N23	M9	G13	D22
3	79P	M10	P22	N22	M11	G12	D21
3	80N	M12	P21	N21	M13	F14	J20
3	80P	M14/CLK_OUT1	P20	N20	M15	E15	J19
3	81N	M16	N31	-	M17	F12	E20
-	-	VCC	-	-	-	VCC	VCC
3	81P	M18	N30	M30	M19	F13	F20
3	82N	M20	N29	M28	M21	D16	H17
3	82P	M22	N28	M26	M23	D15	H18
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	83N	M24	N27	-	M25	—	J18
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	83P	M26	N26	-	M27	—	H19
3	84N	M28	N25	-	M29	—	G20
3	84P	M30	N24	-	M31	—	G19
-	-	GND	-	-	-	GND	GND
3	85N	N0	N23	-	N1	—	C22
-	-	VCC	-	-	-	VCC	VCC
3	85P	N2	N22	-	N3	—	C21
3	86N	N4	N21	-	-	—	D20
3	86P	N6	N20	-	-	—	C19
3	87N	N8	N19	-	N9	C16	F19
3	87P	N10	N18	-	N11	B16	E19
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	88N	N12	N17	-	N13	C15	G18
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	88P	N14	N16	-	N15	B15	F18
3	89N	N16	N15	-	N17	E14	B20
3	89P	N18	N14	-	N19	D14	B19
3	90N	N20	N13	-	N21	E13	A20
3	90P	N22	N12	-	N23	A15	A19
3	91N	N24	P19	N19	N25	D12	D18
3	91P	N26	P18	N18	N27	B14	C18
3	92N	N28	P17	N17	N29	C13	G17
3	92P	N30	P16	N16	N31	A14	F16

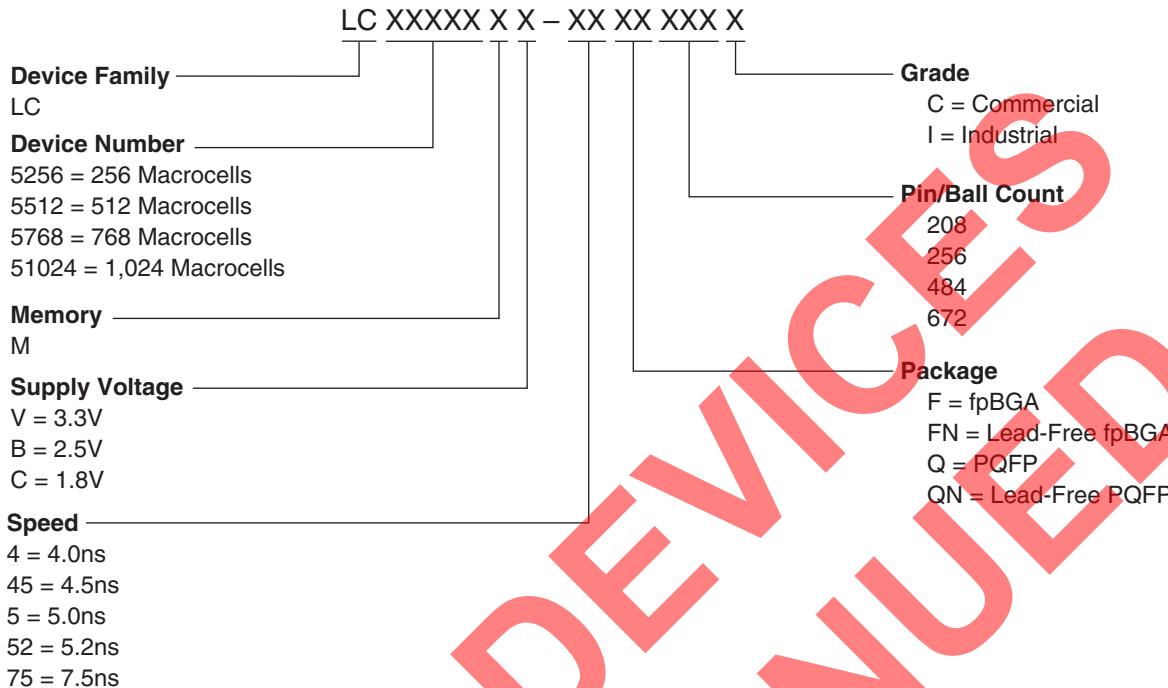
**ispXPLD 5768MX Logic Signal Connections (Continued)**

sysIO Bank	LVDS Pair	Primary Macrocell/ Function	Alternate Outputs		Alternate Inputs	256 fpBGA Ball Number	484 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
-	-	VCC	-	-	-	VCC	VCC
0	109P	Q28	Q30	S30	Q29	A7	C11
-	-	GND	-	-	-	GND	GND
0	110N	Q26	Q29	S29	Q27	D7	B11
0	110P	Q24	Q28	S28	Q25	C7	A11
0	111N	Q22	Q27	S27	Q23	B6	F11
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	111P	Q20	Q26	S26	Q21	E7	F10
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	112N	Q18	Q25	S25	Q19	E6	E10
0	112P	Q16	Q24	S24	Q17	A6	C10
0	113N	Q14/VREF0	Q3	S3	Q15	A5	D10
0	113P	Q12	Q2	S2	Q13	A4	B10
0	114N	Q10	Q23	S23	Q11	B5	A10
0	114P	Q8	Q22	S22	Q9	A3	A9
0	115N	Q6	Q21	S21	Q7	B4	C9
0	115P	Q4	Q20	S20	Q5	B3	D9
0	116N	Q2	Q19	S19	Q3	C5	F9
0	116P	Q0	Q18	S18	Q1	C6	E9
0	117N	R30	Q1	S1	R31	D5	A8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	117P	R28	Q0	S0	R29	D6	B8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	118N	R26	S29	-	R27	—	A7
0	118P	R24	S28	-	R25	—	B7
0	119N	R22	S27	-	R23	—	A5
0	119P	R20	S26	-	R21	—	B5
0	120N	R18	S25	-	R19	—	B6
0	120P	R16	S24	-	R17	—	C7
0	121N	R14	S23	-	R15	—	E8
0	121P	R12	S22	-	R13	—	E7
0	122N	R10	S21	-	R11	—	E6
-	-	VCC	-	-	-	VCC	VCC
0	122P	R8	S20	-	R9	—	D6
-	-	GND	-	-	-	GND	GND
0	123N	R6	S19	-	R7	—	D8
-	-	VCCO0	-	-	-	VCCO0	VCCO0
0	123P	R4	S18	-	R5	—	F8
-	-	GND (Bank 0)	-	-	-	GND (Bank 0)	GND (Bank 0)
0	124N	R2	S17	-	R3	—	F7
0	124P	R0	S16	-	R1	—	D7
0	125N	S30	S15	-	S31	A2	C6
0	125P	S28	S14	-	S29	B2	C5

**ispXPLD 51024MX Logic Signal Connections (Continued)**

sysIO Bank	LVDS Pair	Primary Macrocell/Function	Alternate Outputs		Alternate Input	484 fpBGA Ball Number	672 fpBGA Ball Number
			Macrocell 1	Macrocell 2			
3	126N	W4	V11	U21	W5	B18	E19
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	126P	W6	V10	U20	W7	A18	E18
-	-	GND	-	-	-	GND	GND
3	127N	W8	V9	U18	W9	C17	C24
-	-	VCC	-	-	-	VCC	VCC
3	127P	W10	V8	U16	W11	B17	C23
3	128N	W12	V7	U12	W13	C16	D22
3	128P	W14	V6	U10	W15	B16	D21
3	129N	W16	V5	U8	W17	F13	E21
3	129P	W18	V4	U6	W19	F15	D20
3	130N	W20	V3	U5	W21	D16	D19
3	130P	W22	V2	U4	W23	E16	D18
3	131N	W24	V1	U2	W25	A16	C22
3	131P	W26	V0	U0	W27	A15	C21
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	132N	W28	X15	V15	W29	B15	C20
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	132P	W30	X14	V14	W31	A14	C19
3	133N	X0	X13	V13	X1	D15	C18
3	133P	X2	X12	V12	X3	E15	C17
3	134N	X4	X11	V11	X5	D14	B24
3	134P	X6	X10	V10	X7	F14	B23
3	135N	X8	X9	V9	X9	A13	B22
3	135P	X10	X8	V8	X11	B13	B21
3	136N	X12/VREF3	X29	V29	X13	C14	B20
3	136P	X14	X28	V28	X15	E14	B19
3	137N	X16	X7	V7	X17	E13	B18
3	137P	X18	X6	V6	X19	F12	B17
-	-	GND (Bank 3)	-	-	-	GND (Bank 3)	GND (Bank 3)
3	138N	X20	X5	V5	X21	D13	A24
-	-	VCCO3	-	-	-	VCCO3	VCCO3
3	138P	X22	X4	V4	X23	C13	A23
3	139N	X24	X3	V3	X25	E12	A22
-	-	GND	-	-	-	GND	GND
3	139P	X26	X2	V2	X27	C12	A21
-	-	VCC	-	-	-	VCC	VCC
3	140N	X28	X1	V1	X29	B12	A20
3	140P	X30	X0	V0	X31	A12	A19
0	141N	Y30	Y31	AA31	Y31	E11	A18
-	-	VCC	-	-	-	VCC	VCC
0	141P	Y28	Y30	AA30	Y29	C11	A17
-	-	GND	-	-	-	GND	GND

## Part Number Description



## Ordering Information

Note: For voltage families offered in industrial temperature grades and for all but the slowest commercial speed grade, the speed grades on these devices are dual marked. For example, the commercial speed grade -45XXXXC is also marked with the industrial grade -75I. The commercial grade is always one speed grade faster than the associated dual mark industrial grade. The slowest commercial speed grade is marked as commercial grade only. In addition, the fastest commercial speed grade (-5) for the LC5768MB/MV devices, at Lattice's discretion, will utilize either a commercial grade only single-mark or a dual-mark format in conjunction with the slower industrial speed grade (-75).

### Conventional Packaging

ispXPLD 5000MC (1.8V) Commercial Devices

Device	Part Number	Macrocells	Voltage (V)	t <sub>PD</sub> (ns)	Package	Pin/Ball Count	I/O	Grade
LC5256MC	LC5256MC-4F256C	256	1.8	4.0	fpBGA	256	141	C
	LC5256MC-5F256C	256	1.8	5.0	fpBGA	256	141	C
	LC5256MC-75F256C	256	1.8	7.5	fpBGA	256	141	C
LC5512MC	LC5512MC-45Q208C	512	1.8	4.5	PQFP	208	149	C
	LC5512MC-75Q208C	512	1.8	7.5	PQFP	208	149	C
	LC5512MC-45F256C	512	1.8	4.5	fpBGA	256	193	C
	LC5512MC-75F256C	512	1.8	7.5	fpBGA	256	193	C
	LC5512MC-45F484C	512	1.8	4.5	fpBGA	484	253	C
	LC5512MC-75F484C	512	1.8	7.5	fpBGA	484	253	C